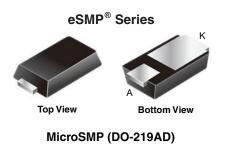
Vishay General Semiconductor

Surface-Mount Schottky Barrier Rectifiers



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Anode O Cathode

LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | |
|--|---------------------|--|--|--|
| I _{F(AV)} | 1.0 A | | | |
| V _{RRM} | 20 V, 30 V | | | |
| I _{FSM} | 25 A | | | |
| V _F at I _F = 1.0 A | 0.35 V | | | |
| T _J max. | 150 °C | | | |
| Package | MicroSMP (DO-219AD) | | | |
| Circuit configuration | Single | | | |

FEATURES

- Very low profile typical height of 0.65 mm
- Ideal for automated placement
- · Low forward voltage drop, low power losses
- High efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: MicroSMP (DO-219AD) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

| MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | | |
|---|-----------------------------------|-------------|---------|------|--|
| PARAMETER | SYMBOL | MSS1P2L | MSS1P3L | UNIT | |
| Device marking code | | 12L | 13L | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 20 30 | | V | |
| Maximum average forward rectified current (fig. 1) | I _{F(AV)} | 1.0 | | А | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 25 | | А | |
| Operating junction and storage temperature range | T _J , T _{STG} | -55 to +150 | | °C | |







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| ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | | | |
|---|------------------------|---|-------------------------------|------|------|------|
| PARAMETER | TEST CO | TEST CONDITIONS | | TYP. | MAX. | UNIT |
| Maximum instantaneous forward voltage | I _F = 0.5 A | T 25 °C | | 0.39 | - | V |
| | I _F = 1.0 A | | | 0.44 | 0.50 | |
| | $I_{F} = 0.5 A$ | – T _J = 125 °C | | 0.28 | - | |
| | I _F = 1.0 A | | | 0.35 | 0.40 | |
| Maximum reverse current | Dated V | Rated V _R $\frac{T_J = 25 \degree C}{T_J = 125 \degree C}$ | I _R ⁽²⁾ | 15 | 250 | μA |
| | naled V _R | | | 6.0 | 20 | mA |
| Typical junction capacitance | 4.0 V, 1 MH | 4.0 V, 1 MHz | | 65 | - | pF |

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

| THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | | |
|--|---------------------------------|---------|---------|------|--|
| PARAMETER | SYMBOL | MSS1P2L | MSS1P3L | UNIT | |
| | R _{0JA} ⁽¹⁾ | 125 | | °C/W | |
| Typical thermal resistance | R _{0JL} ⁽¹⁾ | 30 | | | |
| | R _{0JC} ⁽¹⁾ | 40 | | | |

Note

⁽¹⁾ Thermal resistance from junction to ambient and junction to lead mounted on PCB with 6.0 mm x 6.0 mm copper pad areas $R_{\theta JL}$ is measured at the terminal of cathode band. $R_{\theta JC}$ is measured at the top center of the body

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|-----------------------------------|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | |
| MSS1P2L-M3/89A | 0.006 | 89A | 4500 | 7" diameter plastic tape and reel | | |
| MSS1P2LHM3_A/H ⁽¹⁾ | 0.006 | Н | 4500 | 7" diameter plastic tape and reel | | |

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

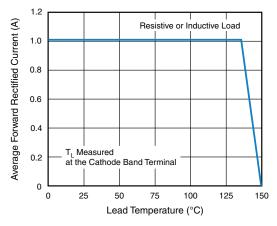


Fig. 1 - Maximum Forward Current Derating Curve

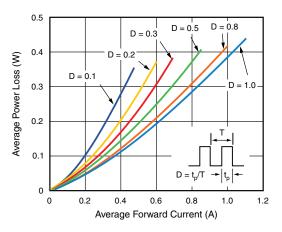


Fig. 2 - Forward Power Loss Characteristics

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Junction to Ambient

Reverse Voltage (V)

Fig. 5 - Typical Junction Capacitance

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10

t - Pulse Duration (s)

Fig. 6 - Typical Transient Thermal Impedance

100

1000

100

1000

100

10

1000

100

10

0.01

0 1

Transient Thermal Impedance (°C/W)

0.1

1

1

Junction Capacitance (pF)

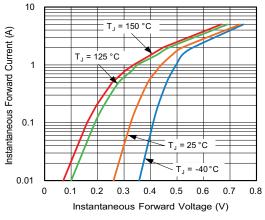
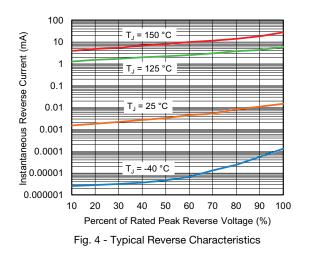
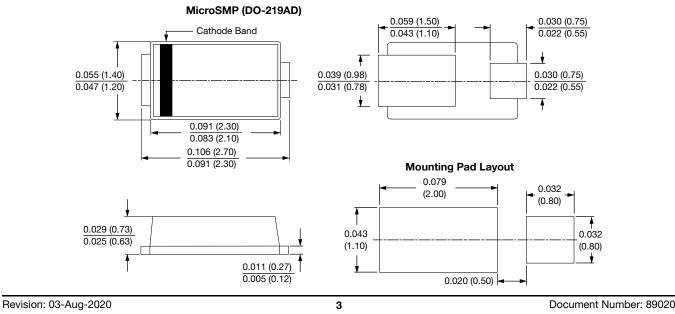


Fig. 3 - Typical Instantaneous Forward Characteristics







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